

(12) INTERNATIONAL APPLICATION PUBLISHED UNDER THE PATENT COOPERATION TREATY (PCT)

(19) World Intellectual Property Organization International Bureau



(43) International Publication Date 11 January 2001 (11.01.2001)

PCT

(10) International Publication Number WO 01/02133 A3

(51) International Patent Classification7:

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- PCT/GB00/01562 (21) International Application Number:
- (22) International Filing Date: 20 April 2000 (20.04.2000)
- (25) Filing Language:

English

B24B 9/06

(26) Publication Language:

English

(30) Priority Data: 9915557.4

3 July 1999 (03.07.1999) GB

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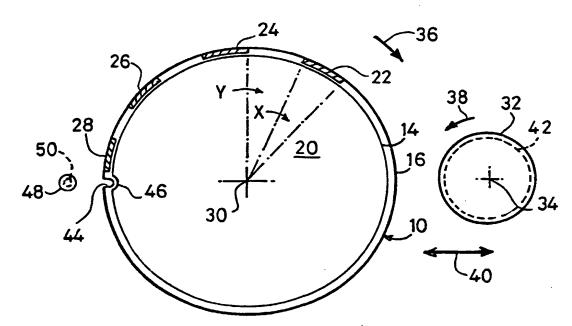
- 90-92 Regent Street, Cambridge CB2 1DP (GB).
- (81) Designated States (national): CN, JP, KR, SG, US.
- (84) Designated States (regional): European patent (AT, BE, CH, CY, DE, DK, ES, FI, FR, GB, GR, IE, IT, LU, MC, NL, PT, SE).

Published:

- With international search report.
- (88) Date of publication of the international search report:

For two-letter codes and other abbreviations, refer to the "Guidance Notes on Codes and Abbreviations" appearing at the beginning of each regular issue of the PCT Gazette.

(54) Title: IMPROVEMENT IN AND RELATING TO EDGE GRINDING



(57) Abstract: A disc-like workpiece (10), such as a semi-conductor wafer, is positioned relative to a grooved grinding wheel (32) by the steps of rotating the workpiece and wheel about respective parallel axes, performing a preliminary grind, measuring the profile of the workpiece rim, axially adjusting the wheel position, performing a second preliminary grind and repeating the steps until the desired accuracy of the profile is achieved. A method and apparatus is also described for forming the edge of a forming wheel, for example using electro-discharge machining.

